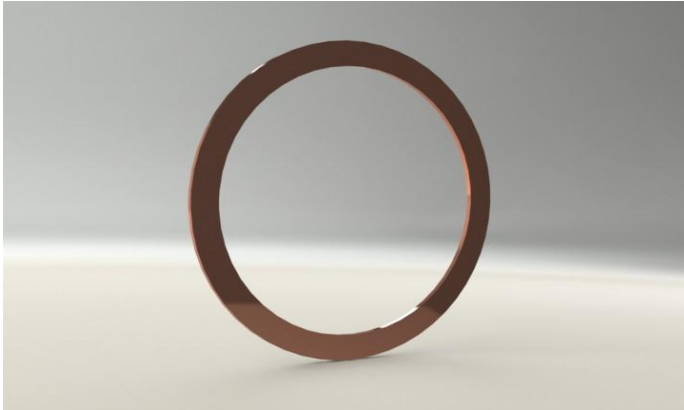


Part Code - CU63



Specification

Material: OFHC Copper

Oxygen free high conductivity (OFHC) copper is a suitable sealing material for bakeable UHV systems because of its good conformity with the thermal expansion coefficient of stainless steel as well as its essentially lower hardness (approx. 85 Brinell).

<i>For Flange OD</i>	<i>D1</i>	<i>D2</i>	<i>Pack size</i>
114 (4.50)	82 (3.23)	63 (2.48)	10

